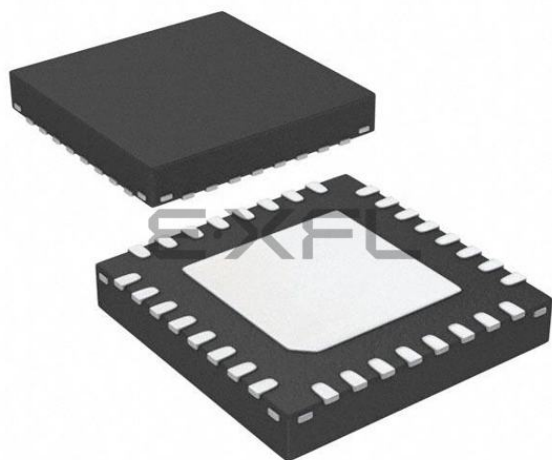




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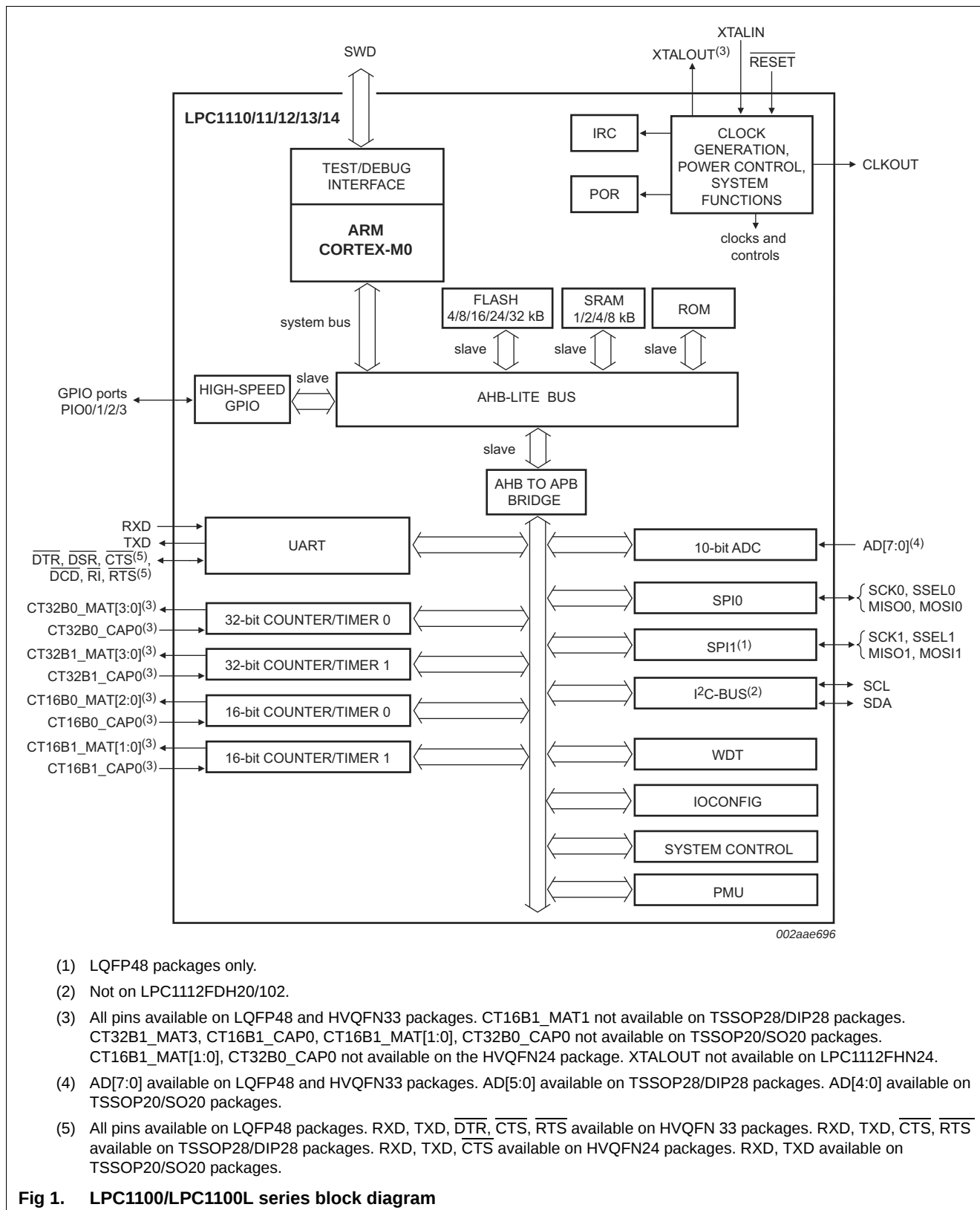
Details

Product Status	Discontinued at Digi-Key
Core Processor	ARM® Cortex®-M0
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	28
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-VQFN Exposed Pad
Supplier Device Package	32-HVQFN (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc1111fhn33-103-5

Table 1. Ordering information ...continued

Type number	Package		
	Name	Description	Version
LPC1114FHI33/302	HVQFN33	HVQFN: plastic thermal enhanced very thin quad flat package; no leads; 33 terminals; body 5 × 5 × 0.85 mm	n/a
LPC1114FHI33/303	HVQFN33	HVQFN: plastic thermal enhanced very thin quad flat package; no leads; 33 terminals; body 5 × 5 × 0.85 mm	n/a
LPC1114JHI33/303	HVQFN33	HVQFN: plastic thermal enhanced very thin quad flat package; no leads; 33 terminals; body 5 × 5 × 0.85 mm	n/a
LPC1114FHN33/203	HVQFN33	HVQFN: plastic thermal enhanced very thin quad flat package; no leads; 33 terminals; body 7 × 7 × 0.85 mm	n/a
LPC1114JHN33/203	HVQFN33	HVQFN: plastic thermal enhanced very thin quad flat package; no leads; 33 terminals; body 7 × 7 × 0.85 mm	n/a
LPC1114FHN33/303	HVQFN33	HVQFN: plastic thermal enhanced very thin quad flat package; no leads; 33 terminals; body 7 × 7 × 0.85 mm	n/a
LPC1114JHN33/303	HVQFN33	HVQFN: plastic thermal enhanced very thin quad flat package; no leads; 33 terminals; body 7 × 7 × 0.85 mm	n/a
LPC1114FHN33/333	HVQFN33	HVQFN: plastic thermal enhanced very thin quad flat package; no leads; 33 terminals; body 7 × 7 × 0.85 mm	n/a
LPC1114JHN33/333	HVQFN33	HVQFN: plastic thermal enhanced very thin quad flat package; no leads; 33 terminals; body 7 × 7 × 0.85 mm	n/a
LPC1113FBD48/301	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1113FBD48/302	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1113FBD48/303	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1113JBD48/303	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1114FBD48/301	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1114FBD48/302	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1114FBD48/303	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1114JBD48/303	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1114FBD48/323	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1114JBD48/323	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1114FBD48/333	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1114JBD48/333	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1115FBD48/303	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2

5. Block diagram



6.2 Pin description

Table 4. LPC1100L series: LPC1110/11/12 pin description table (SO20 and TSSOP20 package with I²C-bus pins)

Symbol	Pin SO20/ TSSOP20	Start logic input	Type	Reset state [1]	Description
PIO0_0 to PIO0_11			I/O		Port 0 — Port 0 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 0 pins depends on the function selected through the IOCONFIG register block.
RESET/PIO0_0	17 [2]	yes	I	I; PU	RESET — External reset input with 20 ns glitch filter. A LOW-going pulse as short as 50 ns on this pin resets the device, causing I/O ports and peripherals to take on their default states, and processor execution to begin at address 0. In deep power-down mode, this pin must be pulled HIGH externally. The RESET pin can be left unconnected or be used as a GPIO pin if an external RESET function is not needed and Deep power-down mode is not used.
			I/O	-	PIO0_0 — General purpose digital input/output pin with 10 ns glitch filter.
PIO0_1/CLKOUT/ CT32B0_MAT2	18 [3]	yes	I/O	I; PU	PIO0_1 — General purpose digital input/output pin. A LOW level on this pin during reset starts the ISP command handler.
			O	-	CLKOUT — Clockout pin.
			O	-	CT32B0_MAT2 — Match output 2 for 32-bit timer 0.
PIO0_2/SSEL0/ CT16B0_CAP0	19 [3]	yes	I/O	I; PU	PIO0_2 — General purpose digital input/output pin.
			I/O	-	SSEL0 — Slave Select for SPI0.
			I	-	CT16B0_CAP0 — Capture input 0 for 16-bit timer 0.
PIO0_4/SCL	20 [4]	yes	I/O	I; IA	PIO0_4 — General purpose digital input/output pin (open-drain).
			I/O	-	SCL — I ² C-bus, open-drain clock input/output. High-current sink only if I ² C Fast-mode Plus is selected in the I/O configuration register.
PIO0_5/SDA	5 [4]	yes	I/O	I; IA	PIO0_5 — General purpose digital input/output pin (open-drain).
			I/O	-	SDA — I ² C-bus, open-drain data input/output. High-current sink only if I ² C Fast-mode Plus is selected in the I/O configuration register.
PIO0_6/SCK0	6 [3]	yes	I/O	I; PU	PIO0_6 — General purpose digital input/output pin.
			I/O	-	SCK0 — Serial clock for SPI0.
PIO0_8/MISO0/ CT16B0_MAT0	1 [3]	yes	I/O	I; PU	PIO0_8 — General purpose digital input/output pin.
			I/O	-	MISO0 — Master In Slave Out for SPI0.
			O	-	CT16B0_MAT0 — Match output 0 for 16-bit timer 0.
PIO0_9/MOSI0/ CT16B0_MAT1	2 [3]	yes	I/O	I; PU	PIO0_9 — General purpose digital input/output pin.
			I/O	-	MOSI0 — Master Out Slave In for SPI0.
			O	-	CT16B0_MAT1 — Match output 1 for 16-bit timer 0.
SWCLK/PIO0_10/ SCK0/ CT16B0_MAT2	3 [3]	yes	I	I; PU	SWCLK — Serial wire clock.
			I/O	-	PIO0_10 — General purpose digital input/output pin.
			I/O	-	SCK0 — Serial clock for SPI0.
			O	-	CT16B0_MAT2 — Match output 2 for 16-bit timer 0.

Table 4. LPC1100L series: LPC1110/11/12 pin description table (SO20 and TSSOP20 package with I²C-bus pins) ...continued

Symbol	Pin SO20/ TSSOP20	Start logic input	Type	Reset state [1]	Description
R/PIO0_11/ AD0/CT32B0_MAT3	4 [5]	yes	I	I; PU	R — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	PIO0_11 — General purpose digital input/output pin.
			I	-	AD0 — A/D converter, input 0.
			O	-	CT32B0_MAT3 — Match output 3 for 32-bit timer 0.
PIO1_0 to PIO1_7			I/O		Port 1 — Port 1 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 1 pins depends on the function selected through the IOCONFIG register block.
R/PIO1_0/ AD1/CT32B1_CAP0	7 [5]	yes	I	I; PU	R — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	PIO1_0 — General purpose digital input/output pin.
			I	-	AD1 — A/D converter, input 1.
			I	-	CT32B1_CAP0 — Capture input 0 for 32-bit timer 1.
R/PIO1_1/ AD2/CT32B1_MAT0	8 [5]	no	O	I; PU	R — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	PIO1_1 — General purpose digital input/output pin.
			I	-	AD2 — A/D converter, input 2.
			O	-	CT32B1_MAT0 — Match output 0 for 32-bit timer 1.
R/PIO1_2/ AD3/CT32B1_MAT1	9 [5]	no	I	I; PU	R — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	PIO1_2 — General purpose digital input/output pin.
			I	-	AD3 — A/D converter, input 3.
			O	-	CT32B1_MAT1 — Match output 1 for 32-bit timer 1.
SWDIO/PIO1_3/ AD4/CT32B1_MAT2	10 [5]	no	I/O	I; PU	SWDIO — Serial wire debug input/output.
			I/O	-	PIO1_3 — General purpose digital input/output pin.
			I	-	AD4 — A/D converter, input 4.
			O	-	CT32B1_MAT2 — Match output 2 for 32-bit timer 1.
PIO1_6/RXD/ CT32B0_MAT0	11 [3]	no	I/O	I; PU	PIO1_6 — General purpose digital input/output pin.
			I	-	RXD — Receiver input for UART.
			O	-	CT32B0_MAT0 — Match output 0 for 32-bit timer 0.
PIO1_7/TXD/ CT32B0_MAT1	12 [3]	no	I/O	I; PU	PIO1_7 — General purpose digital input/output pin.
			O	-	TXD — Transmitter output for UART.
			O	-	CT32B0_MAT1 — Match output 1 for 32-bit timer 0.
V _{DD}	15	-		-	3.3 V supply voltage to the internal regulator, the external rail, and the ADC. Also used as the ADC reference voltage.
XTALIN	14 [6]	-	I	-	Input to the oscillator circuit and internal clock generator circuits. Input voltage must not exceed 1.8 V.
XTALOUT	13 [6]	-	O	-	Output from the oscillator amplifier.
V _{SS}	16	-		-	Ground.

Table 7. LPC1100L series: LPC1112/14 pin description table (TSSOP28 and DIP28 packages) ...continued

Symbol	Pin TSSOP28/ DIP28	Start logic input	Type	Reset state [1]	Description
PIO1_5/RTS/ CT32B0_CAP0	14 [3]	no	I/O	I; PU	PIO1_5 — General purpose digital input/output pin.
			O	-	RTS — Request To Send output for UART.
			I	-	CT32B0_CAP0 — Capture input 0 for 32-bit timer 0.
PIO1_6/RXD/ CT32B0_MAT0	15 [3]	no	I/O	I; PU	PIO1_6 — General purpose digital input/output pin.
			I	-	RXD — Receiver input for UART.
			O	-	CT32B0_MAT0 — Match output 0 for 32-bit timer 0.
PIO1_7/TXD/ CT32B0_MAT1	16 [3]	no	I/O	I; PU	PIO1_7 — General purpose digital input/output pin.
			O	-	TXD — Transmitter output for UART.
			O	-	CT32B0_MAT1 — Match output 1 for 32-bit timer 0.
PIO1_8/ CT16B1_CAP0	17 [3]	no	I/O	I; PU	PIO1_8 — General purpose digital input/output pin.
			I	-	CT16B1_CAP0 — Capture input 0 for 16-bit timer 1.
PIO1_9/ CT16B1_MAT0	18 [3]	no	I/O	I; PU	PIO1_9 — General purpose digital input/output pin.
			O	-	CT16B1_MAT0 — Match output 0 for 16-bit timer 1.
V _{DD}	21	-		-	3.3 V supply voltage to the internal regulator and the external rail.
V _{DDA}	7	-	-	-	3.3 V supply voltage to the ADC. Also used as the ADC reference voltage.
XTALIN	20 [6]	-	I	-	Input to the oscillator circuit and internal clock generator circuits. Input voltage must not exceed 1.8 V.
XTALOUT	19 [6]	-	O	-	Output from the oscillator amplifier.
V _{SS}	22	-		-	Ground.
V _{SSA}	8	-	-	-	Analog ground.

- [1] Pin state at reset for default function: I = Input; O = Output; PU = internal pull-up enabled (pins pulled up to full V_{DD} level); IA = inactive, no pull-up/down enabled.
- [2] 5 V tolerant pad. **RESET** functionality is not available in Deep power-down mode. Use the WAKEUP pin to reset the chip and wake up from Deep power-down mode. An external pull-up resistor is required on this pin for the Deep power-down mode. See [Figure 52](#) for the reset pad configuration.
- [3] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors and configurable hysteresis (see [Figure 51](#)).
- [4] I²C-bus pads compliant with the I²C-bus specification for I²C standard mode and I²C Fast-mode Plus. The pin requires an external pull-up to provide output functionality. When power is switched off, this pin is floating and does not disturb the I²C lines. Open-drain configuration applies to all functions on this pin.
- [5] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors, configurable hysteresis, and analog input. When configured as a ADC input, digital section of the pad is disabled and the pin is not 5 V tolerant (see [Figure 51](#)).
- [6] When the system oscillator is not used, connect XTALIN and XTALOUT as follows: XTALIN can be left floating or can be grounded (grounding is preferred to reduce susceptibility to noise). XTALOUT should be left floating.

Table 8. LPC1100 and LPC1100L series: LPC1113/14 pin description table (LQFP48 package) ...continued

Symbol	Pin	Start logic input	Type	Reset state [1]	Description
SWCLK/PIO0_10/ SCK0/ CT16B0_MAT2	29 ^[3]	yes	I	I; PU	SWCLK — Serial wire clock.
			I/O	-	PIO0_10 — General purpose digital input/output pin.
			I/O	-	SCK0 — Serial clock for SPI0.
			O	-	CT16B0_MAT2 — Match output 2 for 16-bit timer 0.
R/PIO0_11/ AD0/CT32B0_MAT3	32 ^[5]	yes	I	I; PU	R — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	PIO0_11 — General purpose digital input/output pin.
			I	-	AD0 — A/D converter, input 0.
			O	-	CT32B0_MAT3 — Match output 3 for 32-bit timer 0.
PIO1_0 to PIO1_11			I/O		Port 1 — Port 1 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 1 pins depends on the function selected through the IOCONFIG register block.
R/PIO1_0/ AD1/CT32B1_CAP0	33 ^[5]	yes	I	I; PU	R — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	PIO1_0 — General purpose digital input/output pin.
			I	-	AD1 — A/D converter, input 1.
			I	-	CT32B1_CAP0 — Capture input 0 for 32-bit timer 1.
R/PIO1_1/ AD2/CT32B1_MAT0	34 ^[5]	no	O	I; PU	R — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	PIO1_1 — General purpose digital input/output pin.
			I	-	AD2 — A/D converter, input 2.
			O	-	CT32B1_MAT0 — Match output 0 for 32-bit timer 1.
R/PIO1_2/ AD3/CT32B1_MAT1	35 ^[5]	no	I	I; PU	R — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	PIO1_2 — General purpose digital input/output pin.
			I	-	AD3 — A/D converter, input 3.
			O	-	CT32B1_MAT1 — Match output 1 for 32-bit timer 1.
SWDIO/PIO1_3/ AD4/CT32B1_MAT2	39 ^[5]	no	I/O	I; PU	SWDIO — Serial wire debug input/output.
			I/O	-	PIO1_3 — General purpose digital input/output pin.
			I	-	AD4 — A/D converter, input 4.
			O	-	CT32B1_MAT2 — Match output 2 for 32-bit timer 1.
PIO1_4/AD5/ CT32B1_MAT3/ WAKEUP	40 ^[5]	no	I/O	I; PU	PIO1_4 — General purpose digital input/output pin with 10 ns glitch filter. In Deep power-down mode, this pin serves as the Deep power-down mode wake-up pin with 20 ns glitch filter. Pull this pin HIGH externally before entering Deep power-down mode. Pull this pin LOW to exit Deep power-down mode. A LOW-going pulse as short as 50 ns wakes up the part.
			I	-	AD5 — A/D converter, input 5.
			O	-	CT32B1_MAT3 — Match output 3 for 32-bit timer 1.
PIO1_5/RTS/ CT32B0_CAP0	45 ^[3]	no	I/O	I; PU	PIO1_5 — General purpose digital input/output pin.
			O	-	RTS — Request To Send output for UART.
			I	-	CT32B0_CAP0 — Capture input 0 for 32-bit timer 0.

Table 10. LPC1100XL series: LPC1113/14/15 pin description table (LQFP48 and TFBGA48 package) ...continued

Symbol	LQFP48	TFBGA48	Start logic input	Type	Reset state [1]	Description
PIO2_2/ $\overline{\text{DCD}}$ /MISO1	26 ^[3]	G8 ^[3]	no	I/O	I; PU	PIO2_2 — General purpose digital input/output pin.
				I	-	DCD — Data Carrier Detect input for UART.
				I/O	-	MISO1 — Master In Slave Out for SPI1.
PIO2_3/ $\overline{\text{RI}}$ /MOSI1	38 ^[3]	A7 ^[3]	no	I/O	I; PU	PIO2_3 — General purpose digital input/output pin.
				I	-	RI — Ring Indicator input for UART.
				I/O	-	MOSI1 — Master Out Slave In for SPI1.
PIO2_4/ CT16B1_MAT1/ SSEL1	19 ^[3]	G5 ^[3]	no	I/O	I; PU	PIO2_4 — General purpose digital input/output pin.
				O	-	CT16B1_MAT1 — Match output 1 for 16-bit timer 1.
				O	-	SSEL1 — Slave Select for SPI1.
PIO2_5/ CT32B0_MAT0	20 ^[3]	H5 ^[3]	no	I/O	I; PU	PIO2_5 — General purpose digital input/output pin.
				O	-	CT32B0_MAT0 — Match output 0 for 32-bit timer 0.
PIO2_6/ CT32B0_MAT1	1 ^[3]	A1 ^[3]	no	I/O	I; PU	PIO2_6 — General purpose digital input/output pin.
				O	-	CT32B0_MAT1 — Match output 1 for 32-bit timer 0.
PIO2_7/ CT32B0_MAT2/RXD	11 ^[3]	G2 ^[3]	no	I/O	I; PU	PIO2_7 — General purpose digital input/output pin.
				O	-	CT32B0_MAT2 — Match output 2 for 32-bit timer 0.
				I	-	RXD — Receiver input for UART.
PIO2_8/ CT32B0_MAT3/TXD	12 ^[3]	G1 ^[3]	no	I/O	I; PU	PIO2_8 — General purpose digital input/output pin.
				O	-	CT32B0_MAT3 — Match output 3 for 32-bit timer 0.
				O	-	TXD — Transmitter output for UART.
PIO2_9/ CT32B0_CAP0	24 ^[3]	H7 ^[3]	no	I/O	I; PU	PIO2_9 — General purpose digital input/output pin.
				I	-	CT32B0_CAP0 — Capture input 0 for 32-bit timer 0.
PIO2_10	25 ^[3]	H8 ^[3]	no	I/O	I; PU	PIO2_10 — General purpose digital input/output pin.
PIO2_11/SCK0/ CT32B0_CAP1	31 ^[3]	D7 ^[3]	no	I/O	I; PU	PIO2_11 — General purpose digital input/output pin.
				I/O	-	SCK0 — Serial clock for SPI0.
				I	-	CT32B0_CAP1 — Capture input for 32-bit timer 0.
PIO3_0 to PIO3_5				I/O		Port 3 — Port 3 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 3 pins depends on the function selected through the IOCONFIG register block. Pins PIO3_6 to PIO3_11 are not available.
PIO3_0/ $\overline{\text{DTR}}$ / CT16B0_MAT0/TXD	36 ^[3]	B8 ^[3]	no	I/O	I; PU	PIO3_0 — General purpose digital input/output pin.
				O	-	DTR — Data Terminal Ready output for UART.
				O	-	CT16B0_MAT0 — Match output 0 for 16-bit timer 0.
				O	-	TXD — Transmitter Output for UART.
PIO3_1/ $\overline{\text{DSR}}$ / CT16B0_MAT1/RXD	37 ^[3]	A8 ^[3]	no	I/O	I; PU	PIO3_1 — General purpose digital input/output pin.
				I	-	DSR — Data Set Ready input for UART.
				O	-	CT16B0_MAT1 — Match output 1 for 16-bit timer 0.
				I	-	RXD — Receiver input for UART.

Table 11. LPC1100XL series: LPC1111/12/13/14 pin description table (HVQFN33 package) ...continued

Symbol	Pin	Start logic input	Type	Reset state [1]	Description
PIO1_7/TXD/ CT32B0_MAT1	32 ^[3]	no	I/O	I;PU	PIO1_7 — General purpose digital input/output pin.
			O	-	TXD — Transmitter output for UART.
			O	-	CT32B0_MAT1 — Match output 1 for 32-bit timer 0.
PIO1_8/ CT16B1_CAP0	7 ^[3]	no	I/O	I;PU	PIO1_8 — General purpose digital input/output pin.
			I	-	CT16B1_CAP0 — Capture input 0 for 16-bit timer 1.
PIO1_9/ CT16B1_MAT0/ MOSI1	12 ^[3]	no	I/O	I;PU	PIO1_9 — General purpose digital input/output pin.
			O	-	CT16B1_MAT0 — Match output 0 for 16-bit timer 1.
			I/O	-	MOSI1 — Master Out Slave In for SPI1
PIO1_10/AD6/ CT16B1_MAT1/ MISO1	20 ^[5]	no	I/O	I;PU	PIO1_10 — General purpose digital input/output pin.
			I	-	AD6 — A/D converter, input 6.
			O	-	CT16B1_MAT1 — Match output 1 for 16-bit timer 1.
			I/O	-	MISO1 — Master In Slave Out for SPI1
PIO1_11/AD7/ CT32B1_CAP1	27 ^[5]	no	I/O	I;PU	PIO1_11 — General purpose digital input/output pin.
			I	-	AD7 — A/D converter, input 7.
			I	-	CT32B1_CAP1 — Capture input 1 for 32-bit timer 1.
PIO2_0					Port 2 — Port 2 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 2 pins depends on the function selected through the IOCONFIG register block. Pins PIO2_1 to PIO2_11 are not available.
PIO2_0/DTR/SSEL1	1 ^[3]	no	I/O	I;PU	PIO2_0 — General purpose digital input/output pin.
			O	-	DTR — Data Terminal Ready output for UART.
			I/O	-	SSEL1 — Slave Select for SPI1.
PIO3_0 to PIO3_5					Port 3 — Port 3 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 3 pins depends on the function selected through the IOCONFIG register block. Pins PIO3_0, PIO3_1, PIO3_3 and PIO3_6 to PIO3_11 are not available.
PIO3_2/ CT16B0_MAT2/ SCK1	28 ^[3]	no	I/O	I;PU	PIO3_2 — General purpose digital input/output pin.
			O	-	CT16B0_MAT2 — Match output 2 for 16-bit timer 0.
			I/O	-	SCK1 — Serial clock for SPI1.
PIO3_4/ CT16B0_CAP1/RXD	13 ^[3]	no	I/O	I;PU	PIO3_4 — General purpose digital input/output pin.
			I	-	CT16B0_CAP1 — Capture input 1 for 16-bit timer 0.
			I	-	RXD — Receiver input for UART.
PIO3_5/ CT16B1_CAP1/TXD	14 ^[3]	no	I/O	I;PU	PIO3_5 — General purpose digital input/output pin.
			I	-	CT16B1_CAP1 — Capture input 1 for 16-bit timer 1.
			O	-	TXD — Transmitter output for UART.

7. Functional description

7.1 ARM Cortex-M0 processor

The ARM Cortex-M0 is a general purpose, 32-bit microprocessor, which offers high performance and very low power consumption.

7.2 On-chip flash program memory

The LPC1110/11/12/13/14/15 contain 64 kB (LPC1115), 56 kB (LPC1114/333), 48 kB (LPC1114/323), 32 kB (LPC1114), 24 kB (LPC1113), 16 kB (LPC1112), 8 kB (LPC1111) or 4 kB (LPC1110) of on-chip flash memory.

7.3 On-chip SRAM

The LPC1110/11/12/13/14/15 contain a total of 8 kB, 4 kB, 2 kB, or 1 kB on-chip static RAM memory.

7.4 Memory map

The LPC1110/11/12/13/14/15 incorporate several distinct memory regions, shown in the following figures. [Figure 14](#) shows the overall map of the entire address space from the user program viewpoint following reset. The interrupt vector area supports address remapping.

The AHB peripheral area is 2 MB in size, and is divided to allow for up to 128 peripherals. The APB peripheral area is 512 kB in size and is divided to allow for up to 32 peripherals. Each peripheral of either type is allocated 16 kB of space. This allows simplifying the address decoding for each peripheral.

Table 16. Static characteristics (LPC1100, LPC1100L series) ...continued

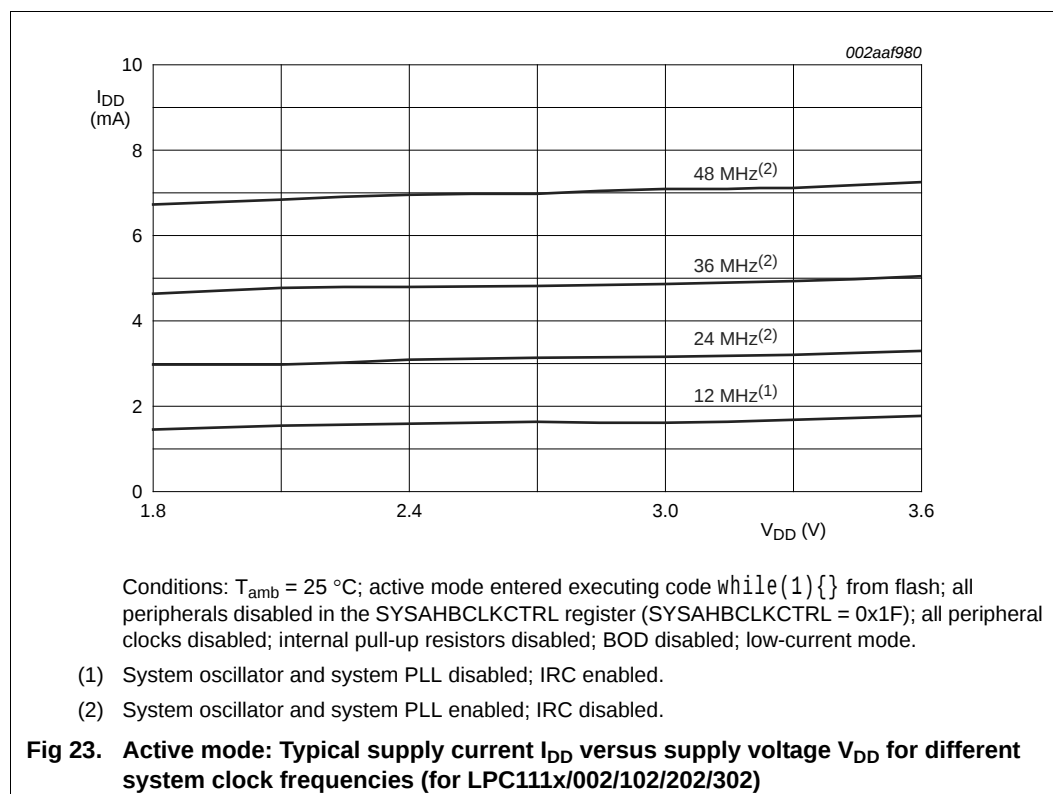
 $T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$, unless otherwise specified.

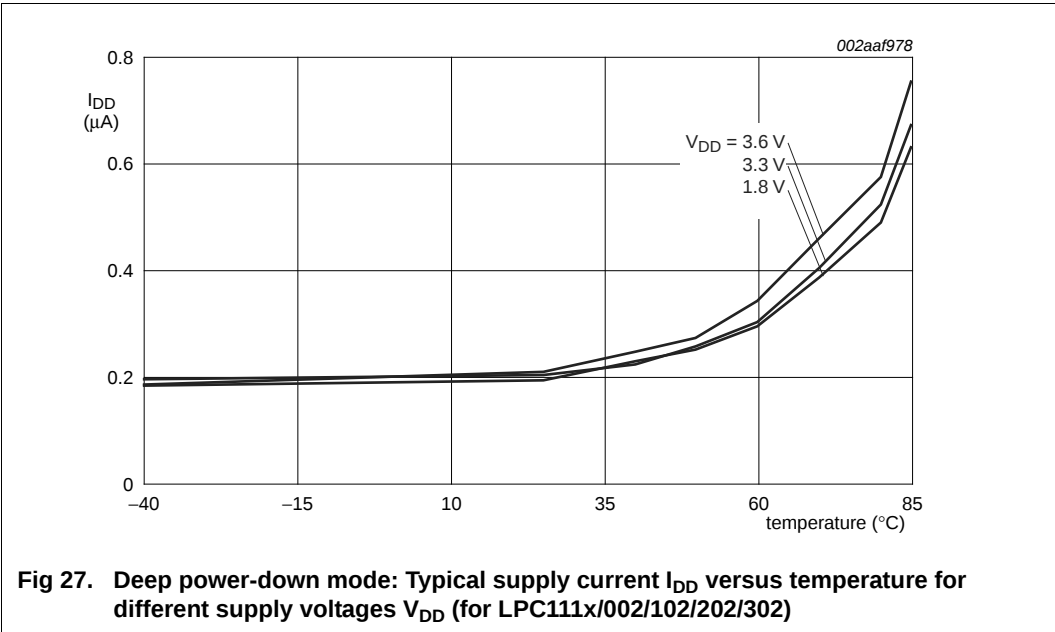
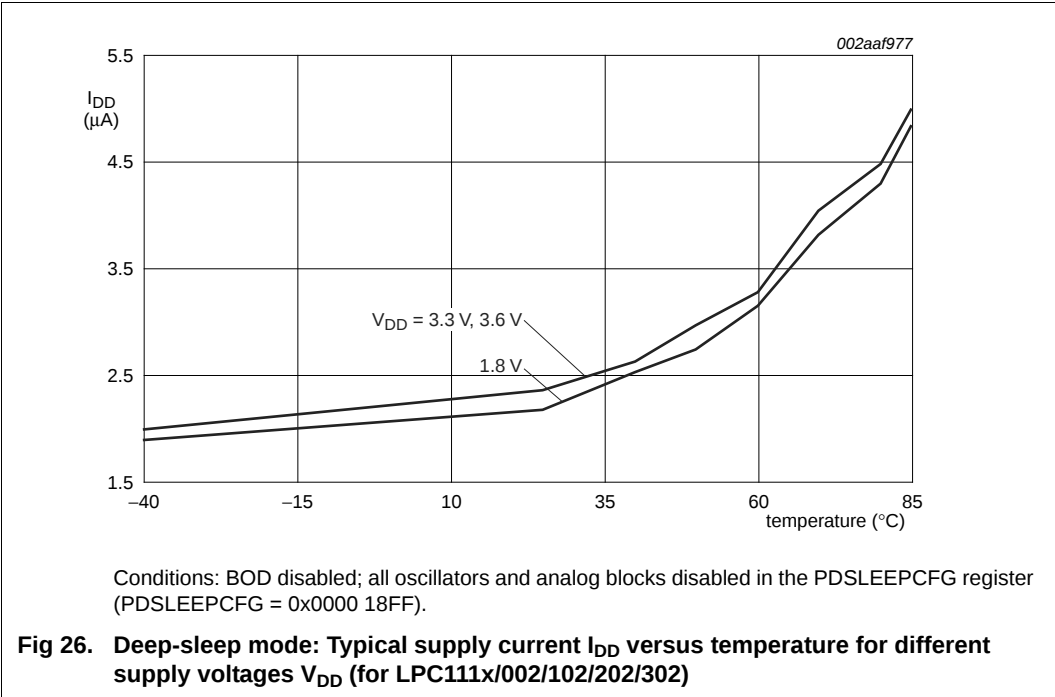
Symbol	Parameter	Conditions	Min	Typ ^[1]	Max	Unit
Standard port pins, RESET						
I _{IL}	LOW-level input current	V _I = 0 V; on-chip pull-up resistor disabled	-	0.5	10	nA
I _{IH}	HIGH-level input current	V _I = V _{DD} ; on-chip pull-down resistor disabled	-	0.5	10	nA
I _{OZ}	OFF-state output current	V _O = 0 V; V _O = V _{DD} ; on-chip pull-up/down resistors disabled	-	0.5	10	nA
V _I	input voltage	pin configured to provide a digital function ^{[12][13][14]}	0	-	5.0	V
V _O	output voltage	output active	0	-	V _{DD}	V
V _{IH}	HIGH-level input voltage		0.7V _{DD}	-	-	V
V _{IL}	LOW-level input voltage		-	-	0.3V _{DD}	V
V _{hys}	hysteresis voltage		-	0.4	-	V
V _{OH}	HIGH-level output voltage	2.5 V ≤ V _{DD} ≤ 3.6 V; I _{OH} = −4 mA	V _{DD} − 0.4	-	-	V
		1.8 V ≤ V _{DD} < 2.5 V; I _{OH} = −3 mA	V _{DD} − 0.4	-	-	V
V _{OL}	LOW-level output voltage	2.5 V ≤ V _{DD} ≤ 3.6 V; I _{OL} = 4 mA	-	-	0.4	V
		1.8 V ≤ V _{DD} < 2.5 V; I _{OL} = 3 mA	-	-	0.4	V
I _{OH}	HIGH-level output current	V _{OH} = V _{DD} − 0.4 V; 2.5 V ≤ V _{DD} ≤ 3.6 V	−4	-	-	mA
		1.8 V ≤ V _{DD} < 2.5 V	−3	-	-	mA
I _{OL}	LOW-level output current	V _{OL} = 0.4 V 2.5 V ≤ V _{DD} ≤ 3.6 V	4	-	-	mA
		1.8 V ≤ V _{DD} < 2.5 V	3	-	-	mA
I _{OHS}	HIGH-level short-circuit output current	V _{OH} = 0 V ^[15]	-	-	−45	mA
I _{OLS}	LOW-level short-circuit output current	V _{OL} = V _{DD} ^[15]	-	-	50	mA
I _{pd}	pull-down current	V _I = 5 V	10	50	150	μA
I _{pu}	pull-up current	V _I = 0 V; 2.0 V ≤ V _{DD} ≤ 3.6 V	−15	−50	−85	μA
		1.8 V ≤ V _{DD} < 2.0 V	−10	−50	−85	μA
		V _{DD} < V _I < 5 V	0	0	0	μA
High-drive output pin (PIO0_7)						
I _{IL}	LOW-level input current	V _I = 0 V; on-chip pull-up resistor disabled	-	0.5	10	nA
I _{IH}	HIGH-level input current	V _I = V _{DD} ; on-chip pull-down resistor disabled	-	0.5	10	nA

10.6 Power consumption LPC1100L series (LPC111x/002/102/202/302)

Power measurements in Active, Sleep, and Deep-sleep modes were performed under the following conditions (see *LPC111x user manual*):

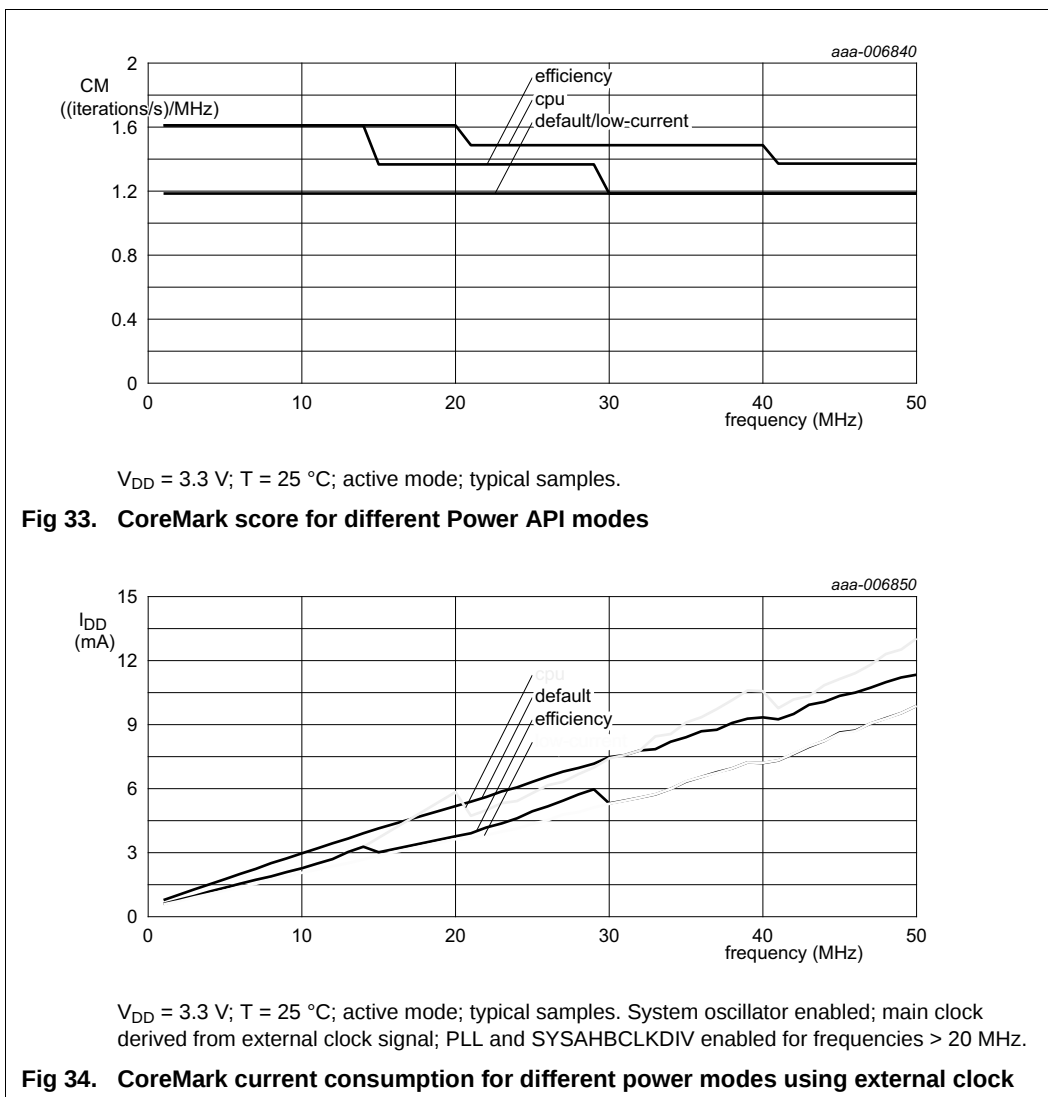
- Configure all pins as GPIO with pull-up resistor disabled in the IOCONFIG block.
- Configure GPIO pins as outputs using the GPIODIR registers.
- Write 0 to all GPIODATA registers to drive the outputs LOW.





10.8 CoreMark data

Remark: All CoreMark data were taken with the Keil uVision v. 4.6 tool.



11. Dynamic characteristics

11.1 Power-up ramp conditions

Table 22. Power-up characteristics^[1]

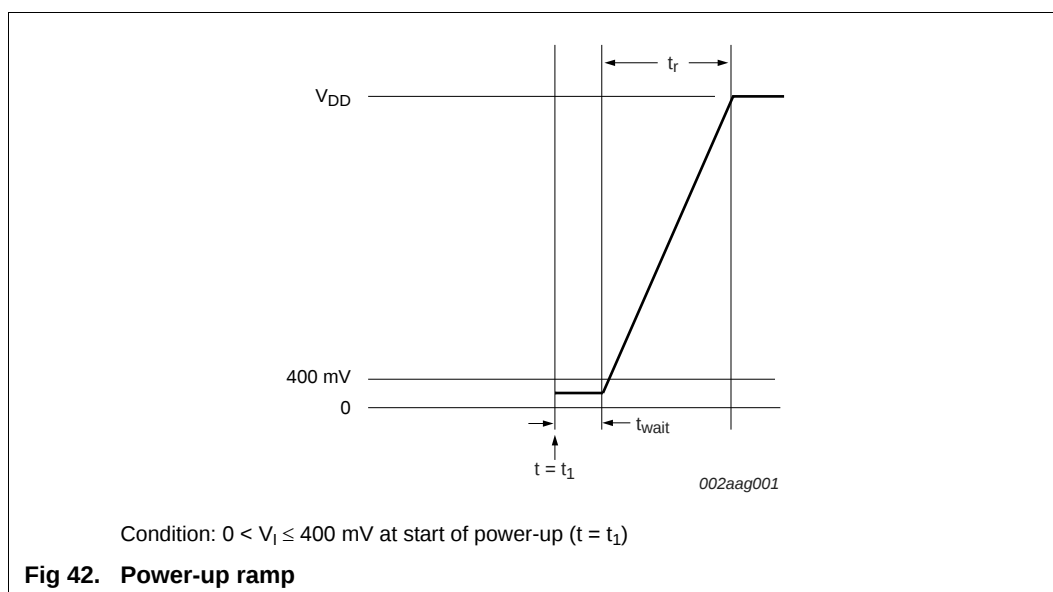
$T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t_r	rise time	at $t = t_1$: $0 < V_I \leq 400\text{ mV}$ ^[2]	0	-	500	ms
t_{wait}	wait time	^{[2][3]}	12	-	-	μs
V_I	input voltage	at $t = t_1$ on pin V_{DD}	0	-	400	mV

[1] Does not apply to the LPC1100XL series (LPC111x/103/203/303/323/333).

[2] See Figure 42.

[3] The wait time specifies the time the power supply must be at levels below 400 mV before ramping up.



11.2 Flash memory

Table 23. Flash characteristics

$T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, unless otherwise specified. $T_{amb} = 85\text{ }^{\circ}\text{C}$ for flash programming.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
N_{endu}	endurance	^[1]	10000	100000	-	cycles
t_{ret}	retention time	powered	10	-	-	years
		unpowered	20	-	-	years
t_{er}	erase time	sector or multiple consecutive sectors	95	100	105	ms
t_{prog}	programming time	^[2]	0.95	1	1.05	ms

[1] Number of program/erase cycles.

[2] Programming times are given for writing 256 bytes from RAM to the flash. Data must be written to the flash in blocks of 256 bytes. Flash programming operation temperature must not exceed $T_{amb} = 85\text{ }^{\circ}\text{C}$.

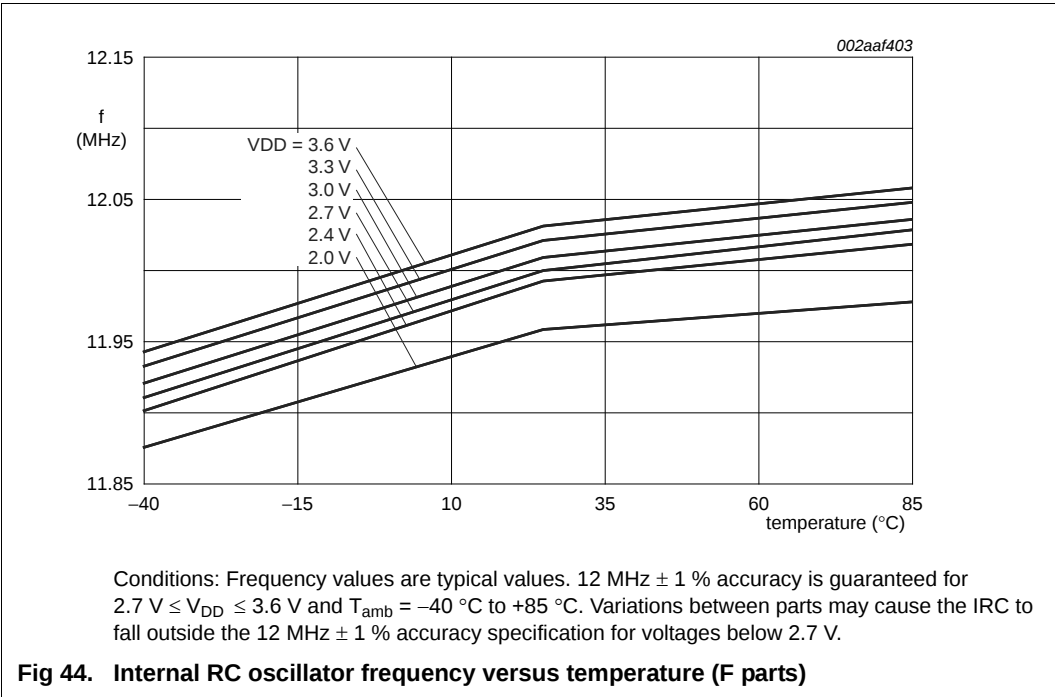
11.4 Internal oscillators

Table 25. Dynamic characteristic: internal oscillators

$T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$; $2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$.^[1]

Symbol	Parameter	Conditions	Min	Typ ^[2]	Max	Unit
$f_{osc(RC)}$	internal RC oscillator frequency	-	11.88	12	12.12	MHz

- [1] Parameters are valid over operating temperature range unless otherwise specified.
- [2] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages.



TSSOP28: plastic thin shrink small outline package; 28 leads; body width 4.4 mm

SOT361-1

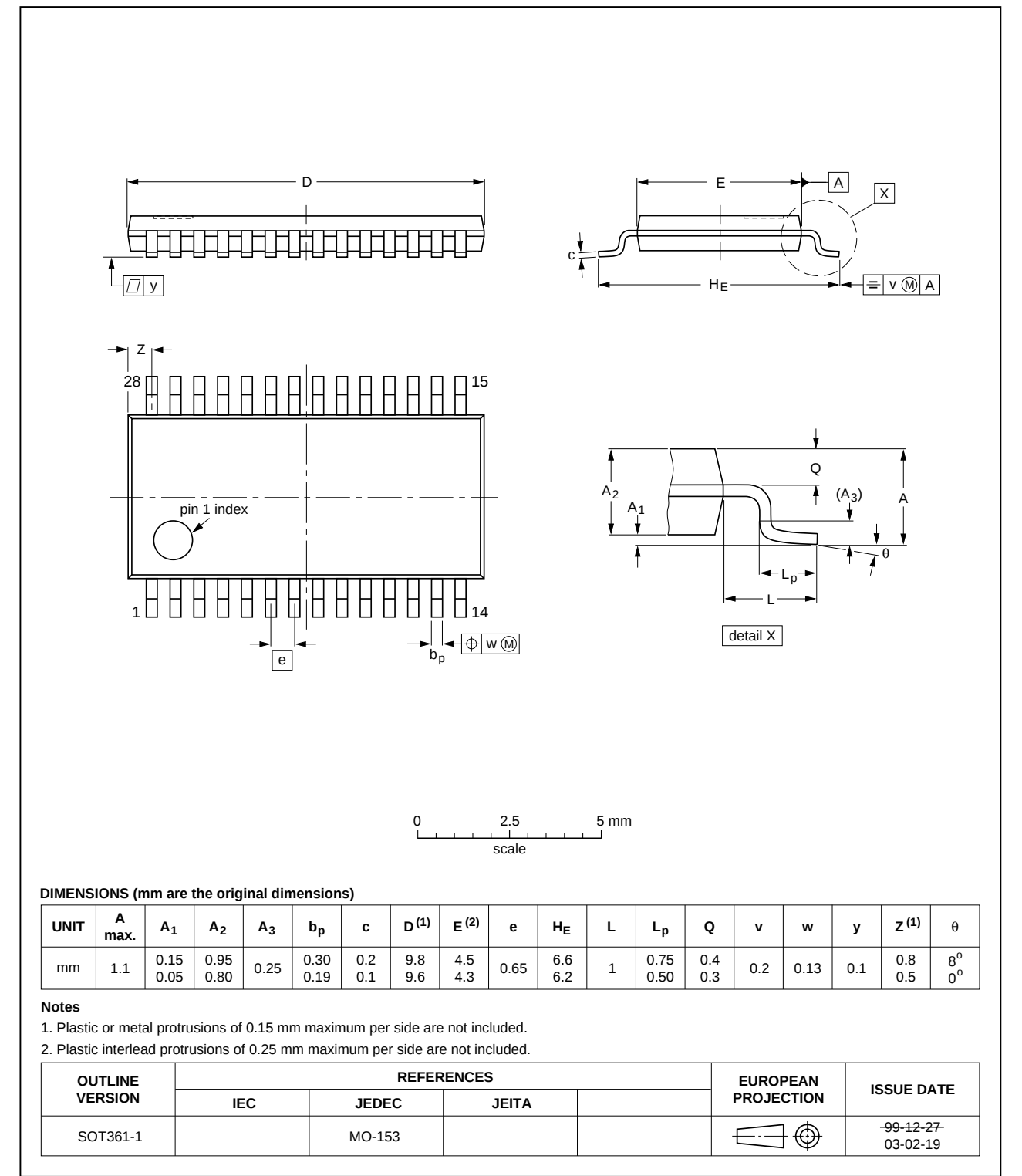


Fig 56. Package outline SOT361-1 (TSSOP28)

HVQFN33: plastic thermal enhanced very thin quad flat package; no leads;
32 terminals; body 5 x 5 x 0.85 mm

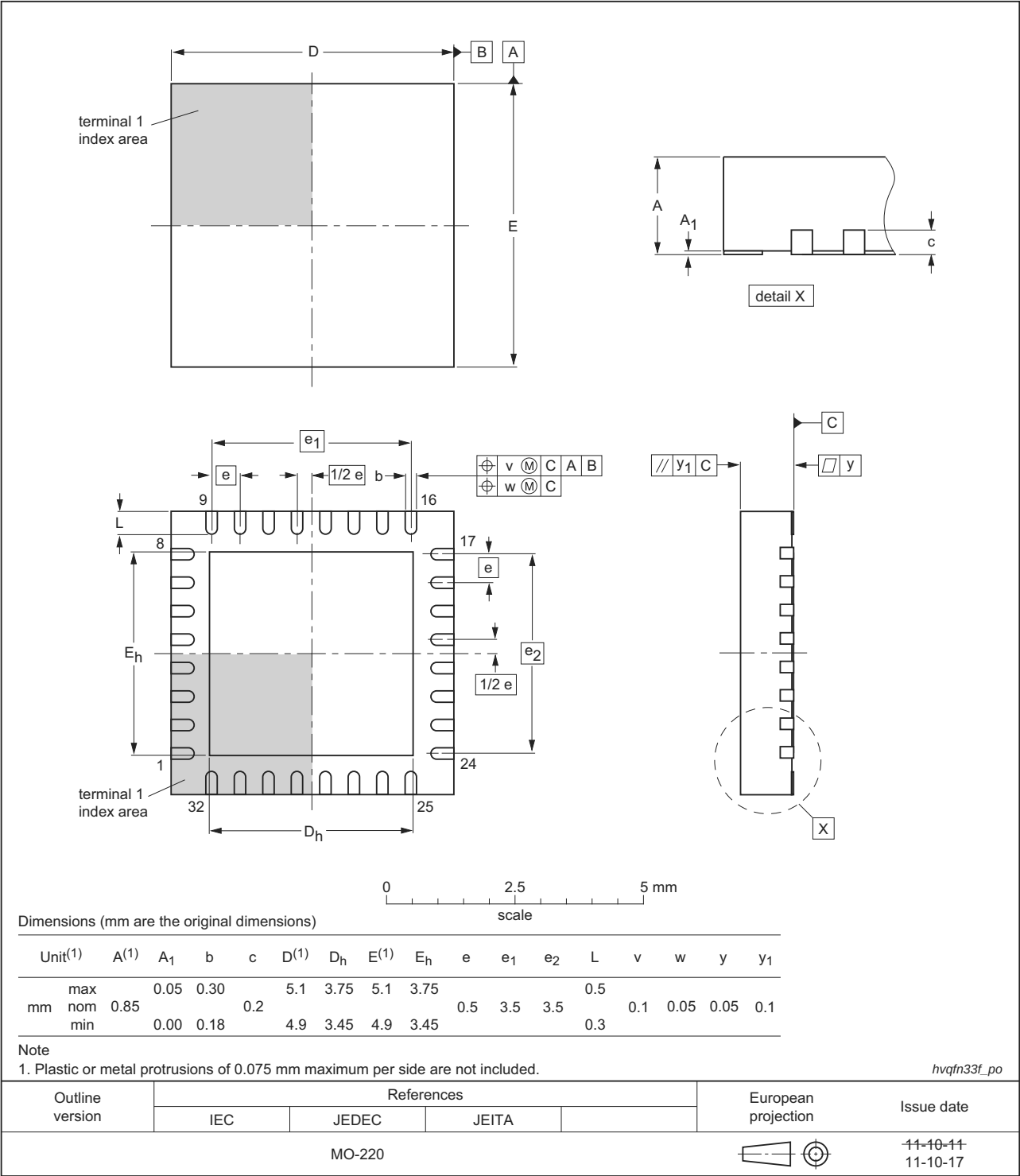
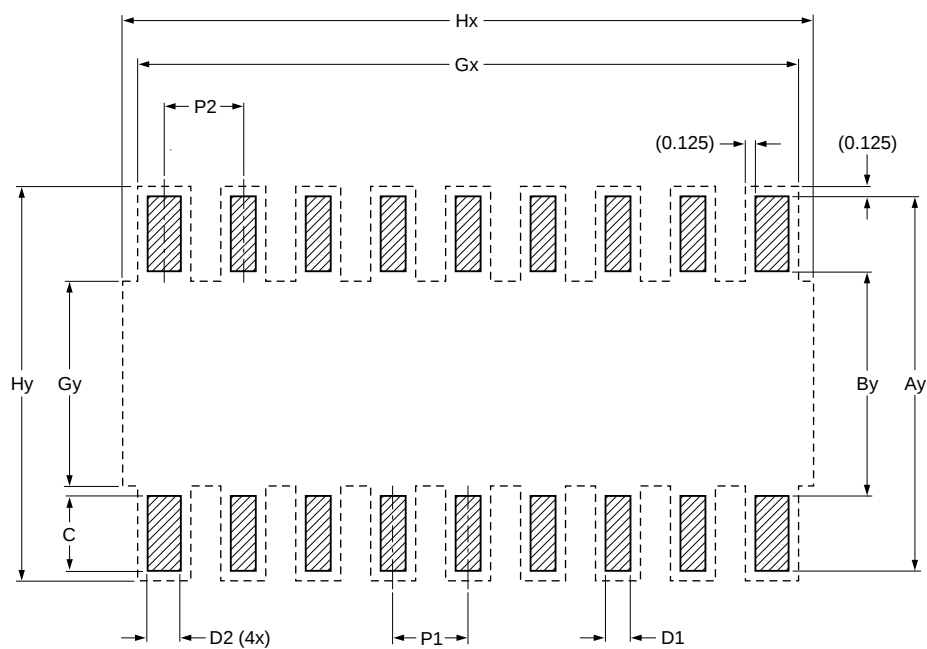


Fig 58. Package outline (HVQFN33 5x5)

Footprint information for reflow soldering of TSSOP28 package

SOT361-1



Generic footprint pattern
Refer to the package outline drawing for actual layout



solder land

--- occupied area

DIMENSIONS in mm

P1	P2	Ay	By	C	D1	D2	Gx	Gy	Hx	Hy
0.650	0.750	7.200	4.500	1.350	0.400	0.600	9.500	5.300	11.800	7.450

sot361-1 fr

Fig 65. Reflow soldering of the TSSOP28 package

17. Revision history

Table 34. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
LPC111X v.9.2	20140326	Product data sheet	-	LPC111X v.9.1
Modifications:	- Pin description tables for RESET/PIO0_0 updated: In deep power-down mode, this pin must be pulled HIGH externally. The RESET pin can be left unconnected or be used as a GPIO pin if an external RESET function is not needed. See Section 6.2. - Pin description notes relating to open-drain I2C-bus pins updated for clarity in Section 6.2. - Pin description of the WAKEUP pin updated for clarity. See Section 6.2. - Parts added: LPC1114JHI33/303, LPC1111JHN33/103, LPC1112JHN33/203, LPC1113JHN33/203, LPC1114JHN33/303, LPC1114JBD48/333, LPC1112FHI33/102, LPC1114JBD48/303, LPC1114JBD48/323, LPC1113JBD48/303, LPC1113JHN33/303, LPC1112JHN33/103, LPC1111JHN33/203, LPC1114JHN33/203.			
LPC111X v.9.1	20131213	Product data sheet	-	LPC111X v.9
Modifications:	- Table 17 "Static characteristics (LPC1100XL series)": - Added I_{DD} max spec for Deep-sleep and Deep power-down modes @ 25 °C and 105 °C. - Added Table note 11 "105 °C spec applies only to the LPC1112JHI33, LPC1114JHN33, LPC1115JBD48, and LPC1115JET48 parts." - Updated Table note 12 "WAKEUP pin and RESET pin are pulled HIGH externally." - Table 16 "Static characteristics (LPC1100, LPC1100L series)": - Updated Table note 9 "WAKEUP pin and RESET pin are pulled HIGH externally."			
LPC111X v.9	20131029	Product data sheet	-	LPC111X v.8.2
Modifications:	- Added LPC1112JHI33/203, LPC1114JHN33/333, LPC1115JBD48/303, and LPC1115JET48/303 parts. - Removed t_{clk(H)} and t_{clk(L)} from Figure 47 "SPI master timing in SPI mode" and Figure 48 "SPI slave timing in SPI mode"; spec not characterized. - Table 22 "Power-up characteristics[1]": Added table note "Does not apply to LPC1100XL series".			
LPC111X v.8.2	20130805	Product data sheet	-	LPC111X v.8.1
Modifications:	Added LPC1115FET48/303.			
LPC111X v.8.1	20130524	Product data sheet	-	LPC111X v.8
Modifications:	- Table 4 thru Table 11: Added "5 V tolerant pad" to RESET/PIO0_0 table note. - Added Section 9 "Thermal characteristics". - SRAM size corrected for part LPC1112FHN24/202 (4 kB). See Table 2.			
LPC111X v.8	20130220	Product data sheet	-	LPC111X v.7.5
Modifications:	- Table 16 "Static characteristics" added Pin capacitance section. - Default pin state corrected for pins PIO0_4 and PIO0_5 (I; IA) in Table 11 "LPC1100XL series: LPC1111/12/13/14 pin description table (HVQFN33 package)". - Table 12 "Limiting values" expanded for clarity. - Table 19 "Power consumption at very low frequencies using the watchdog oscillator" added. - Added Section 12.2 "Use of ADC input trigger signals". - Added Section 12.8 "ADC effective input impedance".			
LPC111X v.7.5	20121002	Product data sheet	-	LPC111X v.7.4

Table 34. Revision history ...continued

Document ID	Release date	Data sheet status	Change notice	Supersedes
Modifications:	- Power consumption graphs added for parts LPC111x/102/202/302 (Figure 13 to Figure 17). - Parameter V_{hys} for I²C bus pins: typical value corrected $V_{\text{hys}} = 0.05V_{\text{DD}}$ in Table 7. - Typical value for parameter N_{endu} added in Table 12 "Flash characteristics". - I²C-bus pins configured as standard mode pins, parameter I_{OL} changed to 3.5 mA (minimum) for $2.0\text{ V} \leq V_{\text{DD}} \leq 3.6\text{ V}$. - Section 11.6 "ElectroMagnetic Compatibility (EMC)" added. - Power-up characterization added (Section 10.1 "Power-up ramp conditions").			
LPC1111_12_13_14 v.3	20101110	Product data sheet	-	LPC1111_12_13_14 v.2
Modifications:	- Parts LPC111x/102/202/302 added (LPC1100L series). - Power consumption data for parts LPC111x/102/202/302 added in Table 7. - PLL output frequency limited to 100 MHz in Section 7.15.2. - Description of $\overline{\text{RESET}}$ and WAKEUP functions updated in Section 6. - WDT description updated in Section 7.14. The WDT is a 24-bit timer. - Power profiles added to Section 2 and Section 7 for parts LPC111x/102/202/302.			
LPC1111_12_13_14 v.2	20100818	Product data sheet	-	LPC1111_12_13_14 v.1
Modifications:	V_{ESD} limit changed to -6500 V (min) /+6500 V (max) in Table 6. t_{DS} updated for SPI in master mode (Table 17). - Deep-sleep mode functionality changed to allow BOD and watchdog oscillator as the only analog blocks allowed to remain running in Deep-sleep mode (Section 7.15.5.3). V_{DD} range changed to $3.0\text{ V} \leq V_{\text{DD}} \leq 3.6\text{ V}$ in Table 15. - Reset state of pins and start logic functionality added in Table 3 to Table 5. - Section 7.16.1 added. - Section "Memory mapping control" removed. V_{OH} and I_{OH} specifications updated for high-drive pins in Table 7. - Section 9.4 added.			
LPC1111_12_13_14 v.1	20100416	Product data sheet	-	-